



## Applications

- High-Performance Network Accelerator
- Data Center Accelerator
- High-Performance Computing (HPC)
- Data Processing
- System Modeling
- Market Analysis

## Board Features

- 1x OpenCAPI Interface
- 2x QSFP28 Cages
- Shrouded heatsink with passive and fan cooling options

## FPGA Features

- 3x 100G Ethernet MACs (incl. KR4 RS-FEC)
- 3x 150G Interlaken cores
- 2x PCI Express x16 Gen3 / x8 Gen4 cores

## Summary

The ADM-PCIE-9V3 is a half-length, low profile, PCI Express Add-In Card featuring the powerful and efficient Xilinx Virtex UltraScale Plus VU3P-2 FPGA.

16 lane PCIe Gen3 or 8 lane PCIe Gen4 capable Interface.

Front IO with 2x QSFP28 sockets, each supporting one 100GbE or four 25GbE interfaces. Onboard Ultraport SlimSAS Connector for OpenCAPI Connectivity. Two 1G x72 DDR4-2400 ECC memory banks each provide 8GB of on-board DDR4-2400 memory (72 bits wide).

System monitoring of temperature, voltage, and current gives developers accurate feedback of power utilization for their designs.

This card comes with low-profile and full-height front brackets (low-profile bracket fitted as standard) and an optional blower for low air-flow systems.

## Target Device

Xilinx Virtex UltraScale Plus: XCVU3P-2 (FVC1517)

LUTs = 394k  
FFs = 788k  
DSPs = 2280  
BRAM = 25.3Mb  
URAM = 90.0Mb

- 3x 100G Ethernet MACs (incl. KR4 RS-FEC)
- 3x 150G Interlaken cores
- 2x PCI Express x16 Gen3 / x8 Gen4 cores

## Application Data Memory

2x FBGA-SDRAM 1G x 72 (8GiB) DDR4-2400

## Other User Memory

2kb I2C EEPROM - Non-volatile data storage for the user design (i.e. storing MAC addresses)

## FPGA Configuration Memory

QSPI 1Gbit Flash Memory  
Configured as 2 x 512Mbit zones

## FPGA Configuration Modes

From onboard Flash  
Through USB board management (built-in JTAG)  
Partial Reconfiguration (via MCAP) Over PCI Express

## Deliverables

ADM-PCIE-9V3 Board  
One Year Warranty  
One Year Technical Support  
Xilinx Vivado board file  
Xilinx SDAccel DSA

## Host Interface

PCI Express Gen3 x16 / Gen4 x8 or OpenCAPI

## Board Format

1/2 Length low profile x16 PCIe form Factor  
Wh-Hd = 174mm x 68.9mm x 17.45mm  
Weight = 230g

## Communications Interfaces

- 2x QSFP28 4x28Gbps - User Configurable, includes 10/25/40/100G Ethernet
- 1x Ultraport SlimSAS 8x25Gbps - OpenCAPI

## Input/Output Interfaces

### Other Interfaces

USB board management (built-in JTAG)  
customizable GPIO

## Board Management

The ADM-PCIE-9V3 houses a system monitoring chip which is able to provide real-time temperature, voltage and current readings of the system, as well as reconfigure programmable clocks and much more. The system monitor can be accessed directly through the USB interface via the front panel, the UART connection to the target FPGA or through the SMBus interface on the card's PCI Express edge connector. When enabled\*\*, IPMI can also be used to communicate with the system monitor, allowing for remote communication and management with the ADM-PCIE-9V3.

\*\* IPMI is disabled by default and should only be enabled when the board is installed in an IPMI compliant system. Please contact the factory for details on enabling IPMI on the ADM-PCIE-9V3.

**Support**

Optional Integrated Board Support Package (BSP) including FPGA example designs, plug and play drivers and API.

**Environmental Specification**
**Temperature Ranges**

Operating Temperature Range : 0°C to +55°C

Storage Temperature Range : -40°C to +85°C

Operating Humidity : Up to 95% (non-condensing)

**EMC Standards**
**EMC Directive 2014/30/EU**

55022:2010

55032:2015

55024:2010 + A1:2015

55035:2017

EN 61000-3-3:2014

EN 61000-3-3:2013

**Additional Declarations:**

FCC/ICFR 47: Part 15: 2016 Radiated Emissions (to 40GHz) Conducted Emissions ANSI C63.4-2014, Class A

**Other Certifications:**

KN32 Class A

KN35

VCCI (V-3/2014.04)

ICES-003 Issue 6

AS/NZS CISPR 22: 2009 + A1:2010

CISPR 22:2008

CISPR 32:2015, Class A

**RoHS Directive 2011/65/EU**

50581: 2012

**Ordering Information**
**Order Code: ADM-PCIE-9V3 (m)(q)(g)**

Option	Code	Description of Options
DDR4 Memory Options	m	blank = 8Gb parts, 8GiB DDR4-2400 per bank, 16GiB total, /32G = 16Gb DDR4-1866 parts, 16GiB per bank, 32 GiB total
QSFP cages and Optical Modules	q	blank = QSFP28 cages only, /Q10 = 2x 40G QSFP Optical module (40GBASE-SR4 150m), /Q14 = 2x 56G QSFP Optical module (56G Infraband 100m), /Q25 = 2x 100G QSFP Optical module (100GBASE-SR4 100m)
GPIO (available in full height bracket only)	g	blank = none, Contact alpha data for customizable options (timing input, RS232, RS485, Direct FPGA Connections)

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